

# **Excellent Integrated System Limited**

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<u>Texas Instruments</u> <u>SN74ALS805ADWG4</u>

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Datasheet of SN74ALS805ADWG4 - IC GATE NOR 6CH 2-INP 20-SOIC

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## SN54ALS805A, SN54AS805B, SN74ALS805A, SN74AS805B HEX 2-INPUT NOR DRIVERS

SDAS023C - DECEMBER 1982 - REVISED JANUARY 1995

- High Capacitive-Drive Capability
- 'ALS805A Has Typical Delay Time of 4.2 ns (C<sub>L</sub> = 50 pF) and Typical Power Dissipation of 4.2 mW Per Gate
- 'AS805B Has Typical Delay Time of 2.6 ns (C<sub>L</sub> = 50 pF) and Typical Power Dissipation of 12 mW Per Gate
- Package Options Include Plastic Small-Outline (DW) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) 300-mil DIPs

#### description

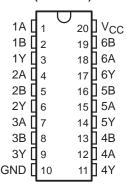
These devices contain six independent 2-input NOR drivers. They perform the Boolean functions  $Y = \overline{A} + \overline{B}$  or  $Y = \overline{A} \bullet \overline{B}$  in positive logic.

The SN54ALS805A and SN54AS805B are characterized for operation over the full military temperature range of -55°C to 125°C. The SN74ALS805A and SN74AS805B are characterized for operation from 0°C to 70°C.

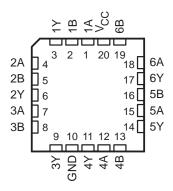
FUNCTION TABLE (each driver)

INP	JTS	OUTPUT
Α	В	Υ
Н	Χ	L
Х	Н	L
L	L	Н

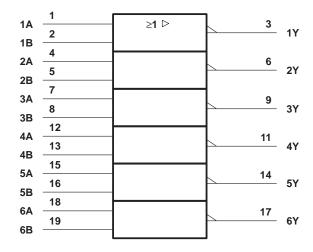
#### SN54ALS805A, SN54AS805B . . . J PACKAGE SN74ALS805A, SN74AS805B . . . DW OR N PACKAGE (TOP VIEW)



## SN54ALS805A, SN54AS805B . . . FK PACKAGE (TOP VIEW)

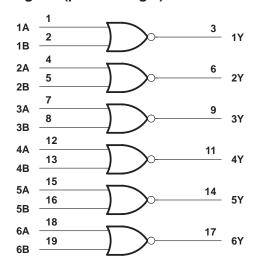


#### logic symbol†



<sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

#### logic diagram (positive logic)



PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.





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# SN54ALS805A, SN54AS805B, SN74ALS805A, SN74AS805B

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**HEX 2-INPUT NOR DRIVERS** 

## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V <sub>CC</sub>		 7 V
Input voltage, V <sub>I</sub>		 7 V
Operating free-air temperature range, T <sub>A</sub> :	SN54ALS805A	 −55°C to 125°C
	SN74ALS805A	 0°C to 70°C
Storage temperature range		 -65°C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

#### recommended operating conditions

		SN54ALS805A			SN7			
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Vcc	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage	2			2			V
VIL	Low-level input voltage			0.7			0.8	V
ІОН	High-level output current			-12			-15	mA
loL	Low-level output current			12			24	mA
TA	Operating free-air temperature	-55		125	0		70	°C

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DADAMETED	TEOT 00	SN5	4ALS80	5A	SN7	5A	LINUT		
PARAMETER	TEST CO	MIN	TYP‡	MAX	MIN	TYP‡	MAX	UNIT	
VIK	$V_{CC} = 4.5 \text{ V},$	I <sub>I</sub> = -18 mA			-1.2			-1.2	V
	$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V},$	$I_{OH} = -0.4 \text{ mA}$	V <sub>CC</sub> -2			V <sub>CC</sub> -2	) :		
Vari		$I_{OH} = -3 \text{ mA}$	2.4	3.2		2.4	3.2		V
VOH	V <sub>CC</sub> = 4.5 V	$I_{OH} = -12 \text{ mA}$	2						V
		$I_{OH} = -15 \text{ mA}$				2			
V.	V 45V	I <sub>OL</sub> = 12 mA		0.25	0.4		0.25	0.4	V
VOL	V <sub>CC</sub> = 4.5 V	$I_{OL} = 24 \text{ mA}$					0.35	0.5	V
lį	$V_{CC} = 5.5 \text{ V},$	V <sub>I</sub> = 7 V			0.1			0.1	mA
lН	$V_{CC} = 5.5 \text{ V},$	V <sub>I</sub> = 2.7 V			20			20	μΑ
I <sub>Ι</sub> Γ	$V_{CC} = 5.5 \text{ V},$	V <sub>I</sub> = 0.4 V			-0.1			-0.1	mA
ΙΟ <sup>§</sup>	V <sub>CC</sub> = 5.5 V,	V <sub>O</sub> = 2.25 V	-20		-112	-30		-112	mA
ICCH	V <sub>CC</sub> = 5.5 V,	V <sub>I</sub> = 0		2	4		2	4	mA
ICCL	$V_{CC} = 5.5 V,$	V <sub>I</sub> = 4.5 V		8	14		8	14	mA

 $<sup>\</sup>ddagger$  All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ .



<sup>§</sup> The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, IOS.



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## SN54ALS805A, SN54AS805B, SN74ALS805A, SN74AS805B HEX 2-INPUT NOR DRIVERS

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### switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V <sub>(</sub> C <sub>I</sub> R <sub>I</sub> T <sub>Z</sub>	UNIT			
	,		SN54AL	S805A	SN74AL	S805A	
			MIN	MAX	MIN	MAX	1
t <sub>PLH</sub>	A or B	v	1	12	2	7	ne
<sup>t</sup> PHL	AUB	· '	1	9	2	8	ns

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Supply voltage, V <sub>CC</sub>	7 V
Input voltage, V <sub>I</sub>	7 V
Operating free-air temperature range, T <sub>A</sub> : SN54AS805B	
SN74AS805B	0°C to 70°C
Storage temperature range	65°C to 150°C

<sup>‡</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

## recommended operating conditions§

		SN54AS805B			SN			
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
VCC	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage	2			2			V
VIL	Low-level input voltage			8.0			0.8	V
loн	High-level output current			-40			-48	mA
lOL	Low-level output current			40			48	mA
TA	Operating free-air temperature	-55		125	0		70	°C

<sup>§</sup> These high sink- or source-current devices are not recommended for use above 40 MHz.





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# SN54ALS805A, SN54AS805B, SN74ALS805A, SN74AS805B HEX 2-INPUT NOR DRIVERS

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#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

			SN	54AS80	5B	SN	74AS80	5B	
PARAMETER	TEST CO	MIN	TYP <sup>†</sup>	MAX	MIN	TYP <sup>†</sup>	MAX	UNIT	
VIK	$V_{CC} = 4.5 \text{ V},$	$I_{I} = -18 \text{ mA}$			-1.2			-1.2	V
	$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V},$	$I_{OH} = -2 \text{ mA}$	V <sub>CC</sub> -2	2		V <sub>CC</sub> -2			
Vari		$I_{OH} = -3 \text{ mA}$	2.4	3.2		2.4	3.2		.,
VOH	V <sub>CC</sub> = 4.5 V	$I_{OH} = -40 \text{ mA}$	2						V
		$I_{OH} = -48 \text{ mA}$				2			
	V 45V	$I_{OL} = 40 \text{ mA}$		0.25	0.5				
VOL	V <sub>CC</sub> = 4.5 V	I <sub>OL</sub> = 48 mA					0.35	0.5	V
lį	$V_{CC} = 5.5 V,$	$V_I = 7 V$			0.1			0.1	mA
lН	V <sub>CC</sub> = 5.5 V,	V <sub>I</sub> = 2.7 V			20			20	μΑ
llL	V <sub>CC</sub> = 5.5 V,	V <sub>I</sub> = 0.4 V			-0.5			-0.5	mA
1 <sub>0</sub> ‡	V <sub>CC</sub> = 5.5 V,	V <sub>O</sub> = 2.25 V	-50		-200	-50		-200	mA
ICCH	V <sub>CC</sub> = 5.5 V,	V <sub>I</sub> = 0		6.5	10		6.5	10	mA
ICCL	V <sub>CC</sub> = 5.5 V,	V <sub>I</sub> = 4.5 V		20	32		20	32	mA

### switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V <sub>C</sub> C <sub>L</sub> R <sub>L</sub> T <sub>A</sub> SN54A	UNIT			
			MIN	MAX	SN74AS MIN	MAX	
t <sub>PLH</sub>	A or B	V	1	4.8	1	4.3	no
<sup>t</sup> PHL	AUID	ſ	1	4.8	1	4.3	ns

<sup>§</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.



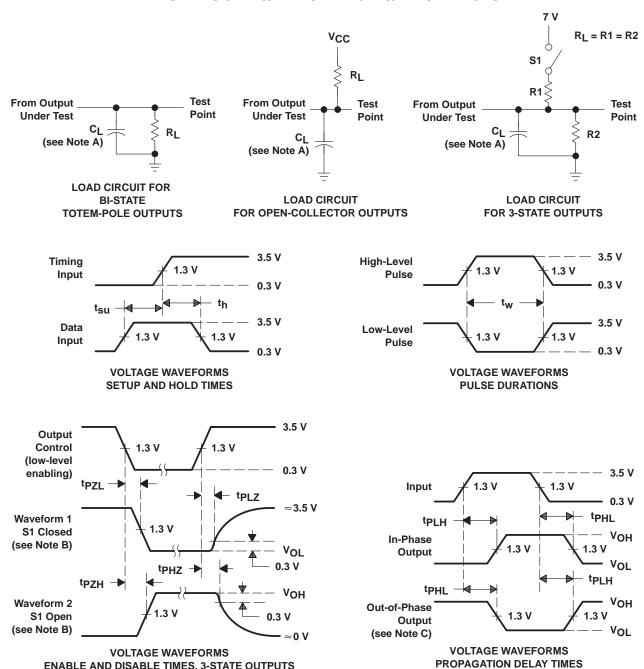
<sup>†</sup> All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C. ‡ The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, I<sub>OS</sub>.

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## SN54ALS805A, SN54AS805B, SN74ALS805A, SN74AS805B **HEX 2-INPUT NOR DRIVERS**

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#### PARAMETER MEASUREMENT INFORMATION SERIES 54ALS/74ALS AND 54AS/74AS DEVICES



NOTES: A. C<sub>L</sub> includes probe and jig capacitance.

**ENABLE AND DISABLE TIMES, 3-STATE OUTPUTS** 

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. When measuring propagation delay items of 3-state outputs, switch S1 is open.
- D. All input pulses have the following characteristics: PRR  $\leq$  1 MHz,  $t_r = t_f = 2$  ns, duty cycle = 50%.
- E. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms





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PACKAGE OPTION ADDENDUM

17-Dec-2015

#### **PACKAGING INFORMATION**

Orderable Device	Status	Package Type	Package	Pins	Package	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
Oraciable bevice	(1)	r dokuge Type	Drawing		Qty	(2)	(6)	(3)	op remp ( o)	(4/5)	oumpies
5962-87794012A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	5962- 87794012A SNJ54AS 805BFK	Samples
5962-8869401SA	OBSOLETE	CFP	W	20		TBD	Call TI	Call TI	-55 to 125		
SN54ALS805AJ	OBSOLETE	CDIP	J	20		TBD	Call TI	Call TI	-55 to 125		
SN74ALS805ADWR	OBSOLETE	SOIC	DW	20		TBD	Call TI	Call TI	0 to 70		
SN74ALS805ADWRE4	OBSOLETE	SOIC	DW	20		TBD	Call TI	Call TI	0 to 70		
SN74ALS805ADWRG4	OBSOLETE	SOIC	DW	20		TBD	Call TI	Call TI	0 to 70		
SN74ALS805AN3	OBSOLETE	PDIP	N	20		TBD	Call TI	Call TI	0 to 70		
SN74AS805BDW	OBSOLETE	SOIC	DW	20		TBD	Call TI	Call TI	0 to 70	AS805B	
SN74AS805BN	OBSOLETE	PDIP	N	20		TBD	Call TI	Call TI	0 to 70	SN74AS805BN	
SNJ54ALS805AFK	OBSOLETE	LCCC	FK	20		TBD	Call TI	Call TI	-55 to 125		
SNJ54ALS805AJ	OBSOLETE	CDIP	J	20		TBD	Call TI	Call TI	-55 to 125		
SNJ54AS805BFK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	5962- 87794012A SNJ54AS 805BFK	Samples

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design. PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

information and additional product content details.

TBD: The Pb-Free (RoHS): Tl's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between

the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability



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PACKAGE OPTION ADDENDUM

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(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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#### OTHER QUALIFIED VERSIONS OF SN54ALS805A, SN54AS805B, SN74ALS805A, SN74AS805B:

- Catalog: SN74ALS805A, SN74AS805B
- Military: SN54ALS805A, SN54AS805B

NOTE: Qualified Version Definitions:

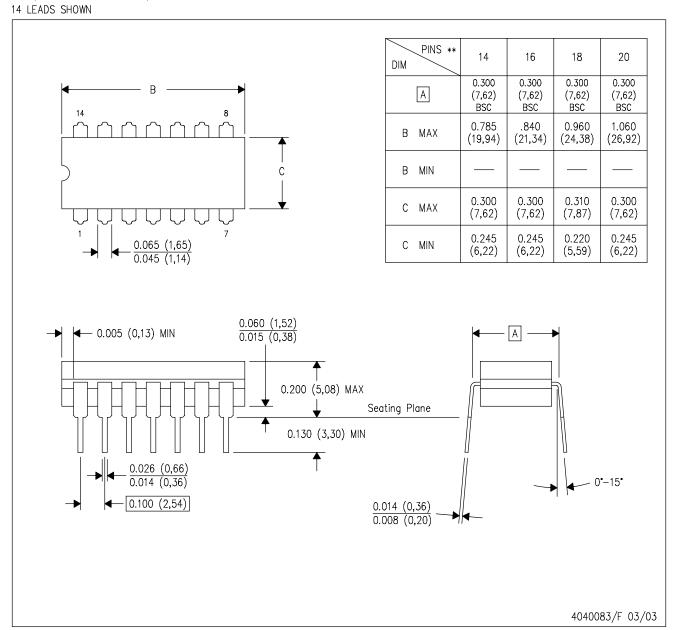
- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications

Addendum-Page 2

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## J (R-GDIP-T\*\*)

## CERAMIC DUAL IN-LINE PACKAGE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

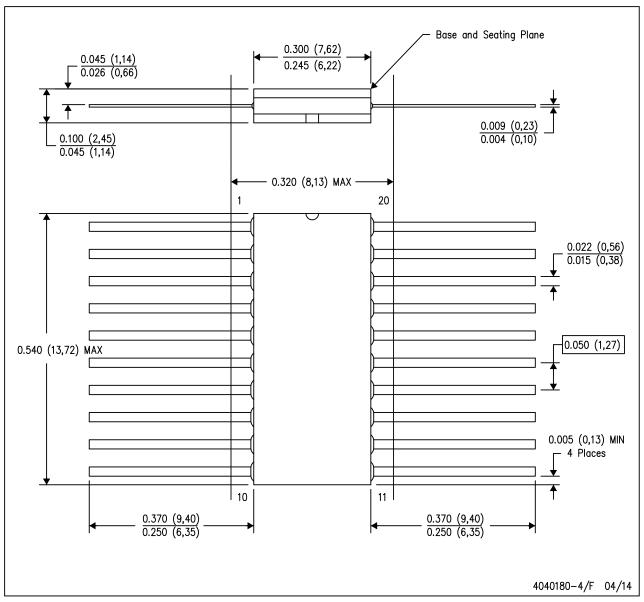




### **MECHANICAL DATA**

W (R-GDFP-F20)

CERAMIC DUAL FLATPACK



- All linear dimensions are in inches (millimeters).
- В. This drawing is subject to change without notice.
- This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for te E. Falls within Mil—Std 1835 GDFP2—F20 Index point is provided on cap for terminal identification only.





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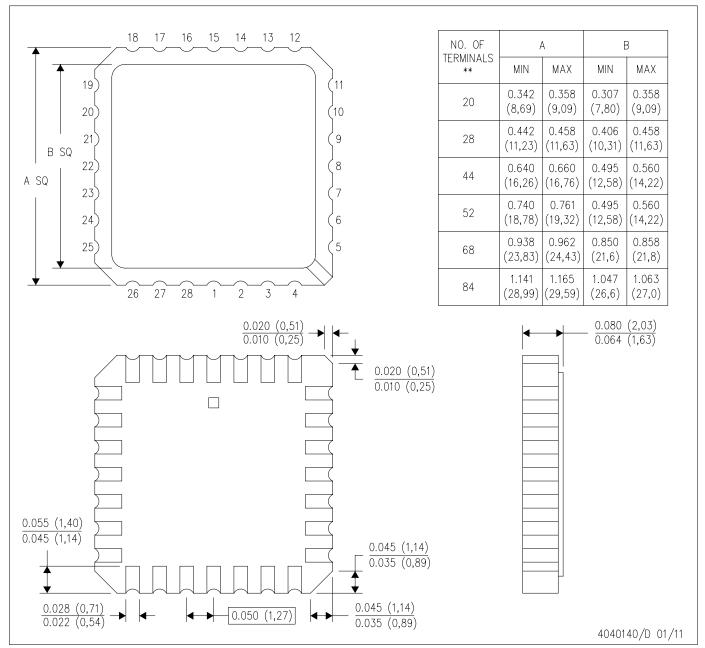
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MECHANICAL DATA

## FK (S-CQCC-N\*\*)

### LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. Falls within JEDEC MS-004

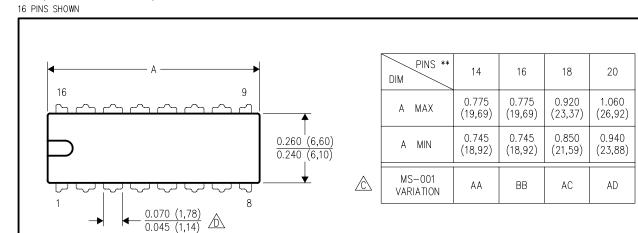


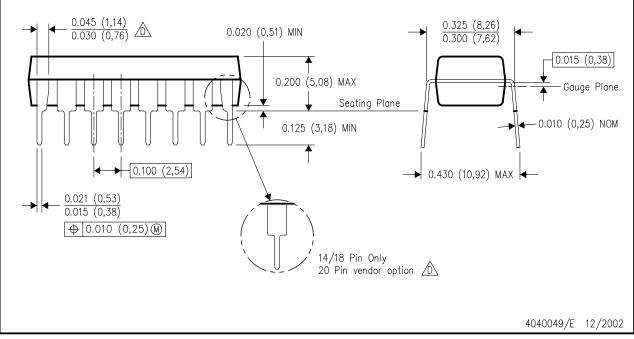


#### **MECHANICAL DATA**

## N (R-PDIP-T\*\*)

## PLASTIC DUAL-IN-LINE PACKAGE





- . All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



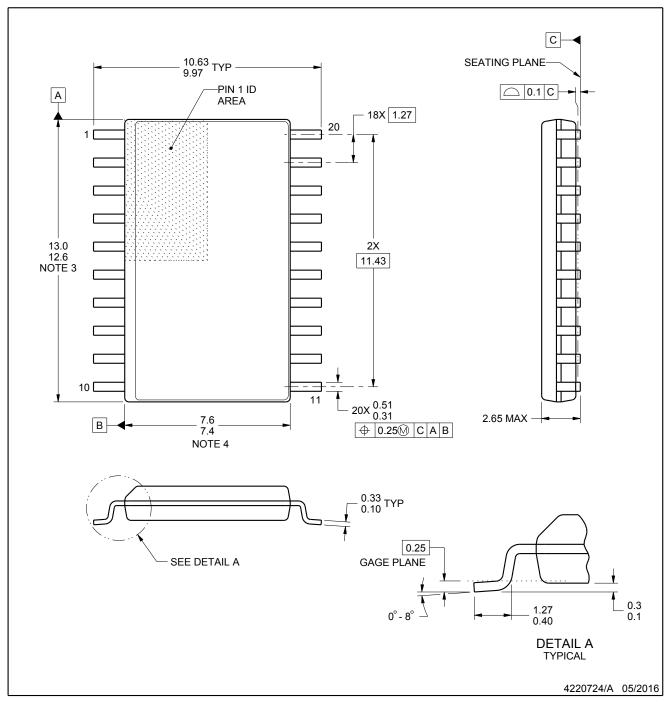


# DW0020A

## **PACKAGE OUTLINE**

SOIC - 2.65 mm max height

SOIC



- 1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm per side.
- 5. Reference JEDEC registration MS-013.



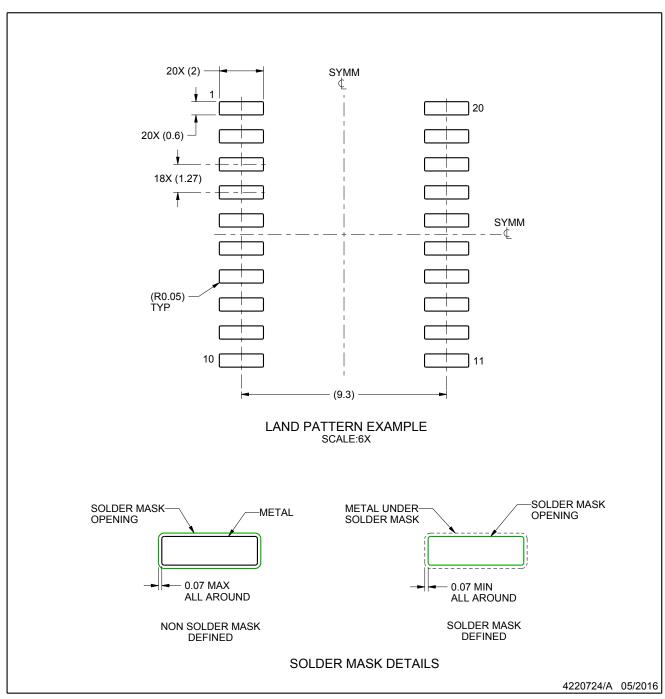


## **EXAMPLE BOARD LAYOUT**

## **DW0020A**

SOIC - 2.65 mm max height

SOIC



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



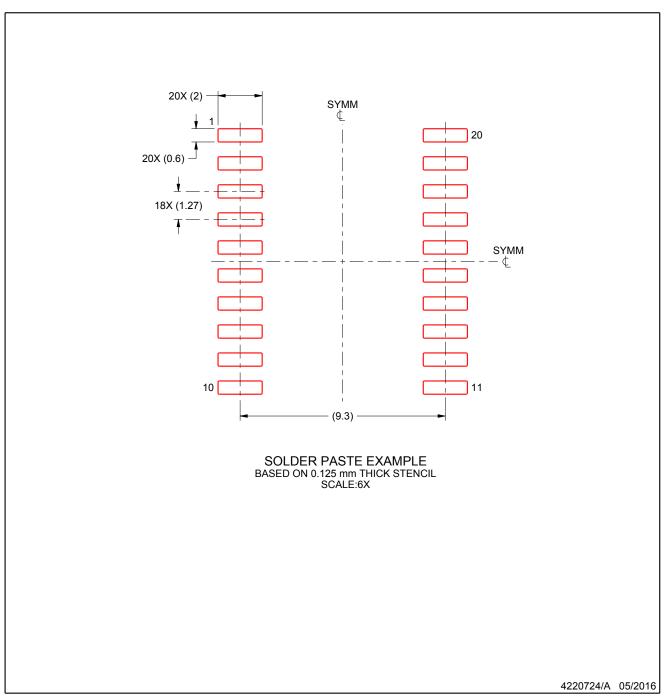


## **EXAMPLE STENCIL DESIGN**

## **DW0020A**

SOIC - 2.65 mm max height

SOIC



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.





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